#### **RoHS Compliant Standard**

# HC-49S-3PIN





#### Features 特性

标称频率: 8.192MHz

Nominal Frequency: 8.192MHz

适用于卓越的CPU时钟信号发生器

Excellent clock signal generator for CPU

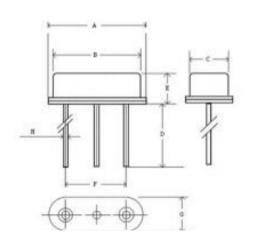
适用于宽广的温度范围

Available in extended temperature range

#### STANDARD SPECIFICATIONS 标准规格

<b>Item</b> Model	HC-49S-3PIN	Conditions
Nominal Frequency 标称频率	8. 192MHz (Fund.)	
Frequency Tolerance 调整频差	±20ppm	at 25℃
Freq. Tol. Over Temp. 温度频差	±30ppm	-40 ~ +85℃
Operating Temp. Range 工作温度范围	-40 ~ +85℃	
Limit temperature range 极限温度范围	- 45~+90℃	
Storage Temp. Range 保存温度范围	-40 ~ +85℃	
Storage humidity range 储存湿度范围	< 70%	
Atmospheric pressure range 大气压力范围	63. 0kPa $\sim$ 106. 0kPa	
Series Resistance 谐振电阻	50ohmMax.	at 25℃
Load Capacitance 负载电容	22 pF	
Shunt Capacitance 静态电容	7.0pF Max.	
Drive Level 激励电平	100μw Max.	
Aging[first year] 第一年老化率	$\pm 5$ ppm Max.	25±3℃
Insulation Resistance 绝缘阻抗	500Mohm Min.	$DC200V \pm 15V$

#### OUTLINE DRAWING OF HC-49S-3PIN (mm)



#### ■ MARKING/印字



Marking Definitions (印字说明):

- 1、FF.FFF/Frequency(中心频率的前五位数字): the first 5 significant digits of center frequency
- 2、YJ: 表示雅晶产品
- 3、YY/Year(年的后两位数字): the last two digit of year(10  $\rightarrow$  2010; 11  $\rightarrow$  2011;12  $\rightarrow$  2012  $\dots$  )
- 4、WW/Week(周代码)

#### 单位为毫米

代码	尺寸	代码	尺寸	代码	尺寸
A	10.90±0.50	В	9.55±0.30	С	3. 50±0.20
D	3.50±0.20	E	3.36±0.30	F	4.88±0.20
G	4.60±0.20	Н	φ0.45±0.10		

# 可靠性1Reliability(Mechanical and Environmental Endura

Page 1 of 2

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No.	Test Items	Test Method and Condition	Requirements
1	振动	(1)振动频率Vibration Frequency 10 to 55Hz	频率变化最大:±10ppm
	Vibration	(2)振动幅度Vibration Amplitude 1.5mm	Frequency Change:±10ppm Max.
		(3)周期 Cycle Time 1-2min(10-55-10Hz)	电阻变化最大:±15%或5ohm
		(4)振动方向Direction X.Y.Z	Resistance Change:±15% or
		(5)振动时间Duration 2h/each direction	50hm Max.
2	跌落	从75cm高的地方自由跌落3次到3cm厚的硬木板上	频率变化最大:±10ppm
	Droping	3 Times free drop from 75cm height to hard wooden	Frequency Change:±10ppm Max.
		board of thickness more than 30mm	电阻变化最大:±15%或5ohm
			Resistance Change:±15% or5ohm Max
3	密封性	晶体放入水中(去气的水中),水面的气压≤8.5KPa,持续10mir	无来自晶体谐振器内部气体或空气
	Leakage	Putting crystal in the water (no gas in the water) for	排出。
			No gas is excluded from the crystal.
4	可焊性	将引线浸入完全熔化的焊锡锅内3-5s,焊锡温度245℃±5℃	润湿力≥理论润湿力的90%
	Solderability	Put the leads of crystal units into solder melted tank for 3 to 5s	Wetting force is more than 90%
		Temperature of solder melted tank is 245 °C±5 °C	of the theory of wetting force
5	可焊性	将引线浸入完全熔化的焊锡锅内3-5s,焊锡温度245℃±5℃	频率变化最大:±10ppm
	Weldability	Put the leads of crystal units into solder melted tank for 3 to 5s	Frequency Change:±10ppm Max.
	Weldomity	Temperature of solder melted tank is $245^{\circ}\text{C} \pm 5^{\circ}\text{C}$	外观无机械损伤
		Temperature of solder mened tank is 245 C = 5 C	Appearance without mechanical
			damage
5	耐焊接热	将晶体的引线浸入260±5℃的焊槽内,持续5±1s.	频率变化最大:±10ppm
	Solder heat	Put the leads of crystal into welding groove for 5±1 s	Frequency Change:±10ppm Max.
	resistance	Temperature of welding groove is 245°C±5°C	电阻变化最大: ±15%或5ohm
			Resistance Change:±15% or 50hm Max.
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# 可靠性2Reliability(Mechanical and Environmental Endurance)

Page 2 of 2

			Page 2 of 2
No.	Test Items	Test Method and Condition	Requirements
6	引线强度	用20N的力持续拉晶体引线10±1s;	频率变化最大:±10ppm
	Lead Strength	用5N的力折引线成90°,3次(折弯处离机体2.5±0.5mm以上);	Frequency Change:±10ppm Max.
		The crystal lead with the 20N power(keep it for $10\mathrm{s}\pm1\mathrm{s}$ )	电阻变化最大: ±15%或5ohm
		Bend the crystal lead 90° with the 20N power and three times. (which you want to bend should be more than 1.5mm from the case)	Resistance Change:±15% or 50hm Max
7	耐高温能力	晶体放置于85℃环境中96小时后,常温放置2小时	频率变化最大:±10ppm
	High Temperature	The crystal units shall be put in somewhere for 96 hours at	Frequency Change:±10ppm Max.
	Endurance	temperature of 85°C, then keep it for 2 hours under room	电阻变化最大:±15%或5ohm
		Resistance Change:±15% or 50hm Max	
8	耐低温能力	晶体放置于-40℃ 环境中96小时后,常温放置2小时	频率变化最大:±10ppm
0	Low Temperature	The crystal units shall be put in somewhere for 96 hours at	Frequency Change:±10ppm Max.
	Endurance	·	
	Endurance	temperature of -40°C, then keep it for 2 hours under room	电阻变化最大: ±15%或5ohm
		temperature	Resistance Change:±15% or 50hm Max
9	高温高湿	晶体放置于85℃ 、85%RH环境中96小时后,常温放置2小时	频率变化最大:±10ppm
	Humidity Endurance	The crystal shall be put in somewhere at 85°C in relative humidity of 85% for 96 hours, then keep it	Frequency Change:±10ppm Max.
			电阻变化最大:±15%或5ohm
		for 2 hours under room temperature	Resistance Change:±15% or 50hm Max
10	温度冲击	温度从-40℃(保持30分钟)升高到85℃(保持30分钟),	频率变化最大:±10ppm
	Temperature Cycle	再降到-40℃(保持30分钟)完成一个循环,温度转换时间	Frequency Change:±10ppm Max.
	F :	2~3 min, 共计5个循环。常温放置2小时	电阻变化最大: ±15%或5ohm
		Temperature shift from low(-40°C) to high(85°C, keep 30 minutes)	
		satisfy high (85°C) to low(-40°C, keep 30 minutes), conversion time	
		for 2~3 min, a total of 5 cycles, then keep it for 2 hours under	
		room temperature	

#### 使用说明Processing Instructions

下面的说明和信息供用户正确理解和使用我们公司的石英晶体系列产品,预防不当的加工方式对石英晶体的损坏,确保用户设备的可靠性

The following instructions and information are provided for the purpose of having the user understand the proper way to process our crystal products to prevent problems prior to use and enhance the reliability of the equipment to which they are applied.

#### PROCESSING INSTRUCTIONS

#### 1 石英晶体意外跌落When dropped by mistake

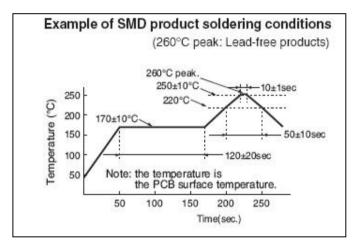
设计和制造的石英晶体本身具有耐冲击能力,但是当石英晶体组件经受剧烈的机械冲击,如跌落到地板上或安装期间剧烈震动时,在使用之前需要进行电性能确认

The crystal units are designed and manufactured to resist physical shocks. However, when the crystal units are subjected to excessive impact such as being dropped onto the floor or giving shocks during processing, need to make sure its satisfactory performance before using it.

#### 2 回流炉焊接曲线Soldering

No.

The REFLOW SOLDERING PROFILE as below is recommended for HC-49S



#### 3 石英晶体组件的清洗CLEANING

(1)恶劣的超声波清洗或超声波焊接可能会影响和损坏石英晶体组件。如果您对晶体组件进行了超声波清洗,请一定在使用确认晶体组件是否受到了影响和损坏

Crystal units may be sffected and destroyed at worst by supersonic cleaning or supersonic welding. Please be sure to check if your cleaning and welding process sffects any damage to crystal units before using.

(2)有些清洗液也可能造成晶体组件的损坏,请在使用清洗液前确认该清洗液是否适用

Some kinds of cleaning fluid may cause any damage to crystal units. Please be sure to check suitability of the cleaning fluid in advance.

#### 4 贮存STORAGE

石英晶体组件长时间贮存在高温或高湿环境中,可能会影响频率的稳定性或可焊性。请将晶体组件贮存在正常的温度和湿力 环境中,避免阳光直射和露水凝结,避免贮存6个月以上再使用,拆封后尽快装配使用。

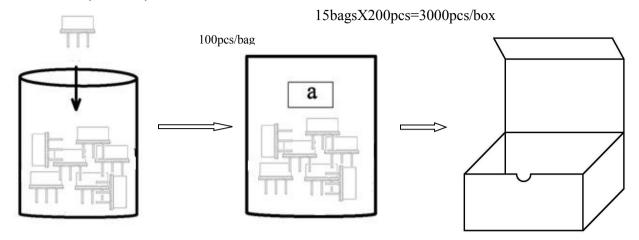
Storage of crystal units under higher temperature or high humidity for a long term may affects frequency stability or solderability.

Please store the crystal units under the normal temperature and humidity without exposing to direct sunlight and dew condensation, and avoid the storage of crystal units for more than 6 months, and mount them as soon as possible after unpacking.

# 包装 PACKING

# **Packing For Pb Free Parts:**

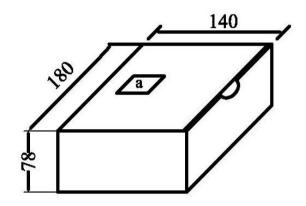
### 1.INNER BOX:(Unit:mm)

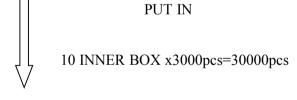


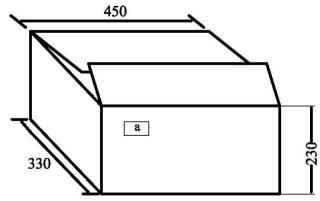
### 2.LOGO STICKER(CARTON and INNER BOX):(Unit:mm)

Label a









Revision	A	Revised	A	initial release	DOC.No.	T-PACKING-49S-01
Date	2015-4-17	records	С		Prepared by	DingLingRong
Issued by	XieShuangShuang	Hold Type		HC-49S-3PIN	Approved by	HeYong